TSUP12H100H Taiwan Semiconductor

12A, 100V Trench Schottky Surface Mount Rectifier

FEATURES

• AEC-Q101 qualified

TAIWAN

- Trench Schottky technology
- Low power loss, high efficiency

EMICONDUCTOR

- Ideal for automated placement
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free

APPLICATIONS

- Switching mode power supply (SMPS)
- Adapters
- Lighting application
- On-board DC/DC converter
- Automotive

MECHANICAL DATA

- Case: TO-277A (SMPC4.6U)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.11g (approximately)

KEY PARAMETERS		
PARAMETER	VALUE	UNIT
lF	12	А
V _{RRM}	100	V
IFSM	360	А
T _{J MAX}	175	°C
Package	TO-277A (SMPC4.6U)	
Configuration	Single die	





TO-277A (SMPC4.6U)

Anode 1 O K Anode 2 O Cathode

ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)			
PARAMETER	SYMBOL	TSUP12H100H	UNIT
Marking code on the device		12H100	
Repetitive peak reverse voltage	Vrrm	100	V
Reverse voltage, total rms value	V _{R(RMS)}	70	V
Forward current	IF	12	А
Surge peak forward current, 8.3ms single half sine wave superimposed on rated load	IFSM	360	А
Junction temperature	TJ	- 55 to +175	°C
Storage temperature	Tstg	- 55 to +175	°C







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THERMAL PERFORMANCE			
PARAMETER	SYMBOL	ТҮР	UNIT
Junction-to-lead thermal resistance ⁽¹⁾	R _{ejl}	2	°C/W
Junction-to-ambient thermal resistance ⁽²⁾	Reja	46	°C/W
Junction-to-case thermal resistance ⁽²⁾	Rejc	8	°C/W

Thermal Performance Notes:

1. With ideal heat sink

2. Units mounted on PCB (16mm x 16mm Cu pad test board)

ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	ТҮР	MAX	UNIT
Forward voltage ⁽¹⁾	I⊧ = 6A, TJ = 25°C	VF	0.60	-	V
	$I_F = 12A, T_J = 25^{\circ}C$		0.70	0.75	V
	I⊧ = 6A, TJ = 125°C		0.50	-	V
	I⊧ = 12A, T」 = 125°C		0.59	0.62	V
Reverse current @ rated $V_R^{(2)}$	T _J = 25°C	IR	-	50	μA
	T _J = 125°C		-	10	mA
Junction capacitance	$1MHz, V_R = 4.0V$	CJ	883	-	pF

Notes:

1. Pulse test with PW = 0.3ms

2. Pulse test with PW = 30ms

ORDERING INFORMATION		
ORDERING CODE	PACKAGE	PACKING
TSUP12H100H	TO-277A (SMPC4.6U)	6,000 / Tape & Reel



CHARACTERISTICS CURVES

(T_A = 25°C unless otherwise noted)

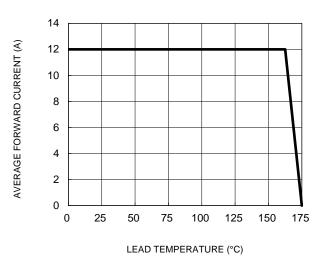
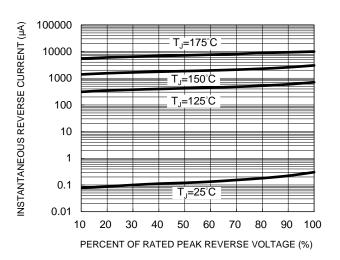
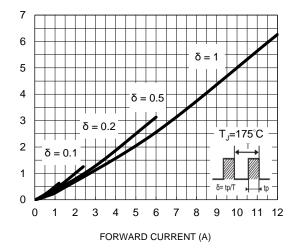


Fig.1 Forward Current Derating Curve









POWER DISSIPATION (W)

 $(1000) \\ (100) \\ (100) \\ (100) \\ (1$

REVERSE VOLTAGE (V)

Fig.4 Typical Forward Characteristics

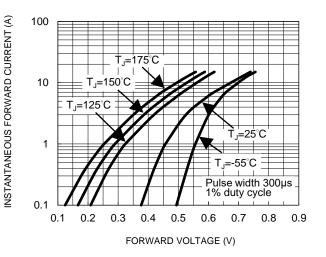


Fig.2 Typical Junction Capacitance



CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

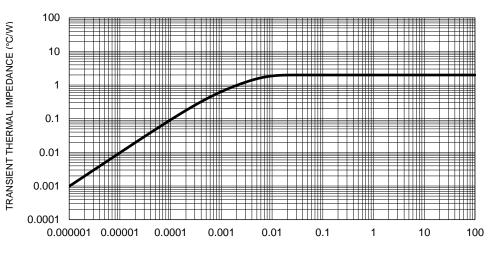
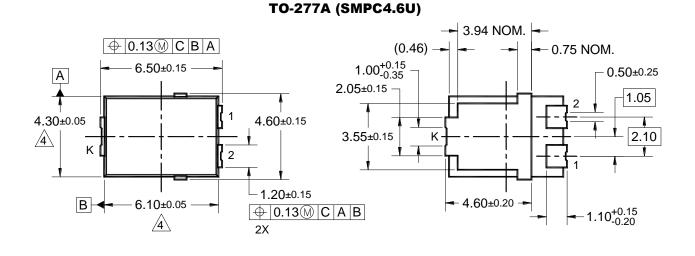


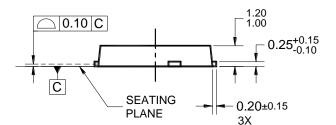
Fig.6 Typical Transient Thermal Characteristics

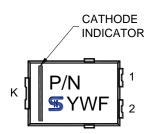
PULSE DURATION (s)



PACKAGE OUTLINE DIMENSIONS

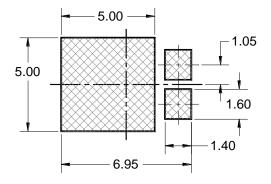






MARKING DIAGRAM

P/N	= MARKING CODE
YW	= DATE CODE
F	= FACTORY CODE



SUGGESTED PAD LAYOUT

NOTES: UNLESS OTHERWISE SPECIFIED

- 1. ALL DIMENSIONS ARE IN MILLIMETERS.
- 2. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
- 3. PACKAGE OUTLINE REFERENCE: JEDEC TO-277 ISSUE A.
- A MOLDED PLASTIC BODY DIMENSIONS DO NOT INCLUDE MOLD LASH, PROTRUSIONS OR GATE BURRS.
- 5. DWG NO. REF: HQ2SD07-SMPC4.6U-031 REV A.



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